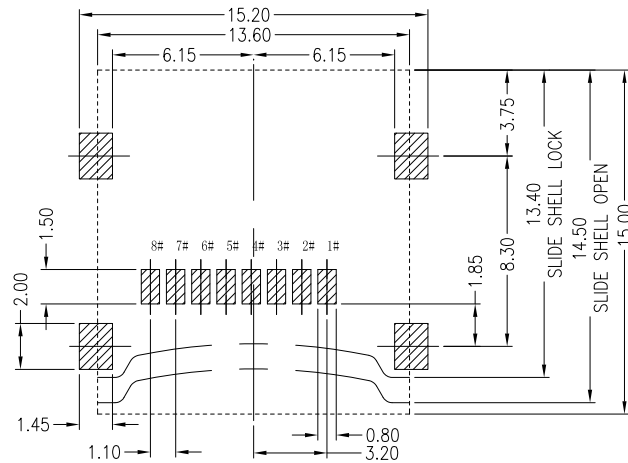
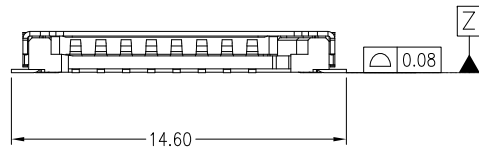
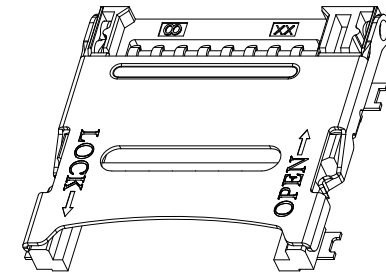
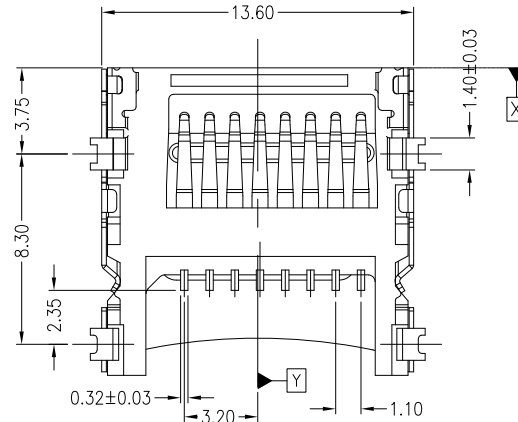
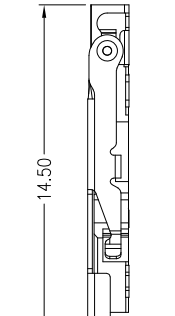
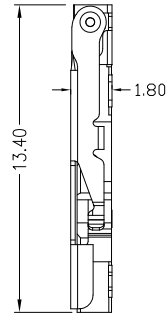
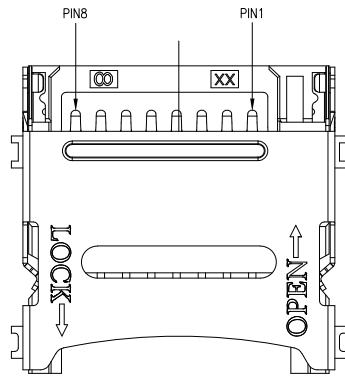


REVISION HISTORY			
REV	DESCRIPTION	Drawing	DATE
01	PROPOSAL	Allen	2020/06/12



NO.	ASSIGNMENT
1#	DAT2
2#	CD/DAT3 ²
3#	CMD
4#	VDD
5#	CLK
6#	VSS
7#	DAT0
8#	DAT1

RECOMMENDED PCB LAYOUT

产品外形 焊盘

NOTE:

- MATERIAL:
 - INSULATOR: HIGH TEMPERATURE THERMOPLASTIC, UL94V-0
 - CONTACT: COPPER ALLOY.
 - SHELL: METAL
- FINISH:
 - CONTACT: PLATED 50u" Ni OVERALL
PLATED 1U"min Au SELECTIVE CONTACT ARED
PLATED 100u" SN OVER Ni ON SOLDER ARED
 - SHELL: PLATED 50u" Ni OVERALL

PRODUCT SPECIFICATION: DOC.No: SP-Axxxx-xx	SCALE 1 : 1	DESIGN UNITS mm
TEST REPORT DOC.No: TR-Axxxx-xx	DRAWN Allen	DATE 2020/06/12
GENERAL TOLERANCES (UNLESS SPECIFIED)	CHECKED	DATE
X.XXX ± 0.10	APPROVED	DATE
X.XX ± 0.25		
X.X ± 0.38		
ANGULAR ± 3°		
THIRD ANGLE PROJECTION	DWG NO. SA0819-001	PART NO. A0819-0001

CHT 群匯科技股份有限公司
CHIUN HUEI Technology CO., LTD.

TITLE
Micro SD Hinge H=1.8

PART NO. A0819-0001	DWG REV. 01	SHEET NO. 1 OF 1
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